

## PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT6505996

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
TATSUYA SHOUJI	12/11/2020
SHUHO KOSEKI	12/11/2020
KENICHI INOUE	12/11/2020
KATSUHIRO OBATA	12/11/2020
SATOSHI MURAKAMI	12/11/2020
NAOKI HAYASHI	12/11/2020
YOSHIKAZU SUZUKI	12/11/2020
TOSHIFUMI MIYAMOTO	12/11/2020
TORU OTOMO	12/11/2020
NOBUHIRO IKEDA	12/11/2020
KOUSUKE UDA	12/11/2020
TAKASHI OGISU	12/11/2020
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	HITACHI METALS, LTD.
<b>Street Address:</b>	2-70, KONAN 1-CHOME, MINATO-KU
<b>City:</b>	TOKYO
<b>State/Country:</b>	JAPAN
<b>Postal Code:</b>	1088224
<b>Name:</b>	TOYOTA JIDOSHA KABUSHIKI KAISHA
<b>Street Address:</b>	1, TOYOTA-CHO, TOYOTA-SHI
<b>City:</b>	AICHI
<b>State/Country:</b>	JAPAN
<b>Postal Code:</b>	4718571
<b>Name:</b>	DAIDO CHEMICAL CO., LTD.
<b>Street Address:</b>	2-2-1400, UMEDA 1-CHOME, KITA-KU, OSAKA-SHI
<b>City:</b>	OSAKA
<b>State/Country:</b>	JAPAN
<b>Postal Code:</b>	5300001
<b>Name:</b>	UMETOKU CO., LTD
<b>Street Address:</b>	3-7, CHAYAMACHI, KITA-KU, OSAKA-SHI

PATENT

<b>City:</b>	OSAKA
<b>State/Country:</b>	JAPAN
<b>Postal Code:</b>	5308377

**PROPERTY NUMBERS Total: 1**

Property Type	Number
<b>Application Number:</b>	17056746

**CORRESPONDENCE DATA**

**Fax Number:** (971)271-8021

*Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.*

**Phone:** 9712718020

**Email:** foreigninbound@mccrus.com

**Correspondent Name:** MCCOY RUSSELL LLP

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<b>ATTORNEY DOCKET NUMBER:</b>	HIB20316PCTUS
<b>NAME OF SUBMITTER:</b>	ANDREW SHUTE
<b>SIGNATURE:</b>	/Andrew Shute/
<b>DATE SIGNED:</b>	01/20/2021

**Total Attachments: 8**

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### ASSIGNMENT

WHEREAS, we, the following named inventors:

1. Tatsuya SHOUJI, residing in Tokyo, Japan;
2. Shuho KOSEKI, residing in Tokyo, Japan;
3. Kenichi INOUE, residing in Tokyo, Japan;
4. Katsuhiro OBATA, residing in Tokyo, Japan;
5. Satoshi MURAKAMI, residing in Tokyo, Japan;
6. Naoki HAYASHI, residing in Aichi, Japan;
7. Yoshikazu SUZUKI, residing in Aichi, Japan;
8. Toshifumi MIYAMOTO, residing in Aichi, Japan;
9. Toru OTOMO, residing in Aichi, Japan;
10. Nobuhiro IKEDA, residing in Nara, Japan;
11. Kousuke UDA, residing in Nara, Japan; and
12. Takashi OGISU, residing in Aichi, Japan,

have invented an invention entitled **METHOD FOR MANUFACTURING FORGED ARTICLE**, for which we have executed an application for Letters Patent of the United States (check one):

- ☐ on the date we executed this assignment;
- ☒ as U.S. Patent Application No. 17/056,746, filed November 18, 2020 ;
- ☐ as International Application No. \_\_\_\_\_, filed \_\_\_\_\_ ;

We authorize the attorneys/agents authorized to act under Customer Number 145572 to insert the filing date and application number of said application when known.

WHEREAS, HITACHI METALS, LTD., TOYOTA JIDOSHA KABUSHIKI KAISHA, DAIDO CHEMICAL CO., LTD., and UMETOKU CO., LTD. ("Assignees"), all Japanese organizations, HITACHI METALS, LTD. having its principal place of business at 2-70, Konan 1-chome, Minato-ku, Tokyo 1088224, Japan, TOYOTA JIDOSHA KABUSHIKI KAISHA having its principal place of business at 1, Toyota-cho, Toyota-shi, Aichi 4718571, Japan, DAIDO CHEMICAL CO., LTD., having its principal place of business at 2-2-1400, Umeda 1-chome, Kita-ku, Osaka-shi, Osaka 5300001, Japan, and UMETOKU CO., LTD. having its principal place of business at 3-7, Chayamachi, Kita-ku, Osaka-shi, Osaka 5308377, Japan, wherein HITACHI METALS, LTD. is desirous of acquiring a 40% interest, TOYOTA JIDOSHA KABUSHIKI KAISHA is desirous of acquiring a 40% interest, DAIDO CHEMICAL CO., LTD. is desirous of acquiring a 10% interest, and UMETOKU CO., LTD. is desirous of acquiring a 10% interest, collectively representing the entire interest therein;

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, we, the above named inventors, have sold, assigned, and transferred, and by these presents do sell, assign, and transfer unto Assignees, the full and exclusive right to the above-identified invention in the United States and its territorial possessions and in all foreign countries, and the entire right, title and interest in and to any and all Letters Patent which may be granted therefor in the United States and its territorial possessions and in any and all foreign countries, and in and to any and all divisions, reissues, continuations and extensions thereof, and all priority rights under all present or future conventions and treaties, and any provisional applications for which priority is claimed.

We hereby authorize and request the Patent Office officials in the United States and any and all foreign countries to issue any and all of said Letters Patent, when granted, to Assignees, as the assignees of our entire right, title and interest in and to the same, for the sole use of the Assignees, their successors and assigns.

Further, we agree that we will communicate to Assignees, or their representatives, any facts known to me/us respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuation, substitution, renewal and reissue applications, execute all necessary assignment

papers to cause any and all of said Letters Patent to be issued to Assignees, make all rightful oaths and generally do everything possible to aid Assignees, their successors and assigns, to obtain and enforce proper protection for said invention in the United States and in any and all foreign countries.

IN TESTIMONY WHEREOF, we have hereunto set our hands on the dates indicated below.

1. Inventor Name: Tatsuya SHOUJI

Signature: Tatsuya SHOUJI Date: December 11, 2020

2. Inventor Name: Shuho KOSEKI

Signature: Shuho Koseki Date: December 11, 2020

3. Inventor Name: Kenichi INOUE

Signature: Kenichi INOUE Date: December 11, 2020

4. Inventor Name: Katsuhiro OBATA

Signature: Katsuhiro OBATA Date: December 11, 2020

5. Inventor Name: Satoshi MURAKAMI

Signature: Satoshi MURAKAMI Date: December 11, 2020

6. Inventor Name: Naoki HAYASHI

Signature: \_\_\_\_\_ Date: \_\_\_\_\_

7. Inventor Name: Yoshikazu SUZUKI

Signature: \_\_\_\_\_ Date: \_\_\_\_\_

8. Inventor Name: Toshifumi MIYAMOTO

Signature: \_\_\_\_\_ Date: \_\_\_\_\_

9. Inventor Name: Toru OTOMO

Signature: \_\_\_\_\_ Date: \_\_\_\_\_

10. Inventor Name: Nobuhiro IKEDA

Signature: \_\_\_\_\_ Date: \_\_\_\_\_

11. Inventor Name: Kousuke UDA

Signature: \_\_\_\_\_ Date: \_\_\_\_\_

12. Inventor Name: Takashi OGISU

Signature: \_\_\_\_\_ Date: \_\_\_\_\_

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1. Inventor Name: Tatsuya SHOUJI

Signature: \_\_\_\_\_ Date: \_\_\_\_\_

2. Inventor Name: Shuho KOSEKI

Signature: \_\_\_\_\_ Date: \_\_\_\_\_

3. Inventor Name: Kenichi INOUE

Signature: \_\_\_\_\_ Date: \_\_\_\_\_

4. Inventor Name: Katsuhiro OBATA

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6. Inventor Name: Naoki HAYASHI

Signature: Naoki Hayashi Date: December 11, 2020

7. Inventor Name: Yoshikazu SUZUKI

Signature: Yoshikazu Suzuki Date: December 11, 2020

8. Inventor Name: Toshifumi MIYAMOTO

Signature: Toshifumi Miyamoto Date: December 11, 2020

9. Inventor Name: Toru OTOMO

Signature: Toru Otomo Date: December 11, 2020

10. Inventor Name: Nobuhiro IKEDA

Signature: \_\_\_\_\_ Date: \_\_\_\_\_

11. Inventor Name: Kousuke UDA

Signature: \_\_\_\_\_ Date: \_\_\_\_\_

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10. Inventor Name: Nobuhiro IKEDA

Signature: 池田 修啓 Date: December 11, 2020

11. Inventor Name: Kousuke UDA

Signature: 宇田 祐介 Date: December 11, 2020

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